

FEATURES

- 92 % peak efficiency**
- 6 MHz operating frequency**
- 38 μ A (typical) no load quiescent current in PFM mode**
- 1.80 V, 1.82 V, 1.85V, 1.875V fixed output voltage**
- 500 mA continuous output current**
- Input voltage :2.3 V to 5.5 V**
- 0.28 μ A (typical) shutdown supply current**
- Automatic power-saving mode**
- Compatible with tiny multilayer inductors**
- Internal synchronous rectifier**
- Internal compensation**
- Internal soft start**
- Output to ground short circuit protection**
- Current-limit protection**
- Enable/shutdown logic input**
- Undervoltage lockout**
- Thermal shutdown**
- Ultra small 6-ball 1.17 mm² WLCSP**

APPLICATIONS

- Mobile phones**
- Digital cameras**
- Digital audio**
- Portable equipment**
- 1-cell Li+/Li-polymer and 3-cell alkaline/nickel**

GENERAL DESCRIPTION

The ADP2121 is a high frequency, low quiescent current, step-down, dc-to-dc converter optimized for portable applications in which board area and battery life are critical constraints. Fixed frequency operation at 6 MHz enables the use of tiny ceramic inductors and capacitors. Additionally the synchronous rectification improves efficiency and results in fewer external components. At high load currents, the device uses a voltage regulating pulse-width modulation (PWM) mode that maintains a constant frequency with excellent stability and transient response. At light load conditions, the ADP2121 can automatically enter a power saving mode that utilizes pulse-frequency modulation (PFM) to reduce the effective switching frequency and ensure the longest battery life in portable applications. During logic controlled shutdown ($EN = 0$), the input is disconnected from the output and draws less than 0.28 μ A (typical) from the source.

The ADP2121 has an input voltage range of 2.3 V to 5.5 V allowing the use of a single Li+/Li-polymer cell, multiple alkaline/Ni-MH cell, PCMCIA, and other standard power sources. The converter is internally compensated to minimize external components, and its 1.80 V, 1.82 V, 1.85 V, or 1.875 V fixed output can source up to 500 mA. Other key features include undervoltage lockout (UVLO) to prevent deep-battery discharge and soft start to prevent input current overshoot at startup.

TYPICAL APPLICATION CIRCUIT

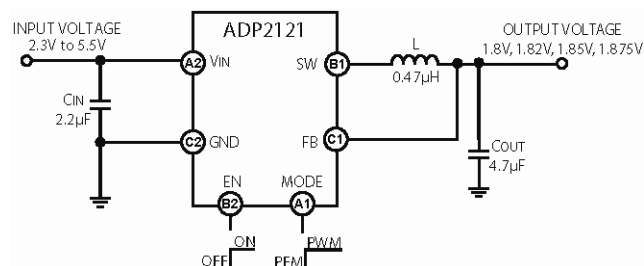


Figure 1. Circuit Configuration of ADP2121

OUTPUT VOLTAGE OPTIONS

Table 1.

Input Voltage Range (V)	Maximum Start-up Time (μ s)	Fixed Output Voltage (V)
2.3 - 5.5	100	1.800, 1.850, 1.875
2.3 - 5.5	300	1.820

TYPICAL PERFORMANCE

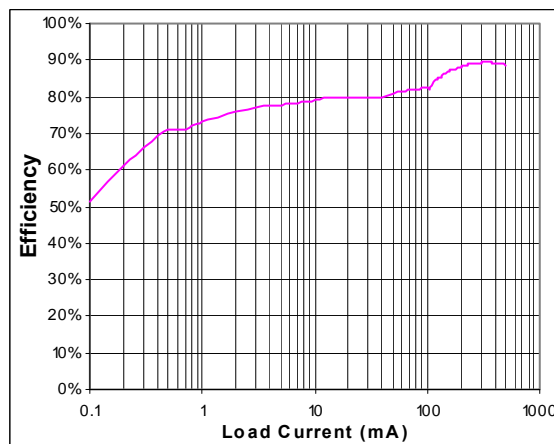


Figure 2. Efficiency vs. Load Current ($V_{IN} = 3.6$ V, $V_{OUT} = 1.82$ V, Auto Mode)

Rev. PrA

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REVISION HISTORY

11/08—Revision PrA: Preliminary Version

SPECIFICATIONS¹

$V_{IN} = EN = 3.6\text{ V}$, all values are at $T_A = 25^\circ\text{C}$.

Table 2.

Parameters	Conditions	Min	Typ	Max	Unit
SUPPLY					
Input Voltage Range	$I_{LOAD} = 0\text{ mA to }400\text{ mA}$	2.3		5.5	V
	$I_{LOAD} = 0\text{ mA to }500\text{ mA}$	2.5		5.5	
Quiescent Current	$V_{IN} = 3.6\text{ V}$ (PFM mode), no load, $T_A = 85^\circ\text{C}$		38	55	μA
	$V_{IN} = 3.6\text{ V}$ (PWM mode), no load		10		mA
Shutdown Current	$V_{EN} = 0\text{ V}$		0.28	0.5	μA
UNDERVOLTAGE LOCKOUT					
Undervoltage Lockout Threshold	V_{IN} rising			2.2	V
	V_{IN} falling	1.8			V
OUTPUT					
Continuous Output Current	$V_{IN} = 2.3\text{ V}$			400	mA
	$V_{IN} = 2.5\text{ V to }5.5\text{ V}$			500	mA
Output Accuracy (1.82 V , $V_{IN} = 3.6$) ²	Auto mode	- 2%	V_{NOM}	+ 3%	V
	PWM mode	- 2%	V_{NOM}	+ 3%	V
Feedback Bias Current	$V_{FB} = 1.8\text{ V}$		3.8		μA
SWITCHING CHARACTERISTICS					
SW On Resistance ($R_{DS(on)}$)	P-channel switch		225	440	m Ω
	N-channel synchronous rectifier		290	810	m Ω
SW Leakage Current	$V_{IN} = 5.5\text{ V}$, $V_{SW} = 0\text{ V}$, 5.5 V			1	μA
SW Current Limit	P-channel switch	850	1000	1150	mA
Oscillator Frequency		5.4	6	6.6	MHz
EFFICIENCY ($V_{IN} = 3.6\text{ V}$, $V_{OUT} = 1.82\text{ V}$)					
	$L = 0.47\text{ }\mu\text{H}$, $C_{OUT} = 4.7\text{ }\mu\text{F}$				
	$I_{LOAD} = 10\text{ mA}$ (PFM mode)		79		%
	$I_{LOAD} = 50\text{ mA}$ (PFM mode)		81		%
	$I_{LOAD} = 150\text{ mA}$ (PWM mode)		87		%
	$I_{LOAD} = 250\text{ mA}$ (PWM mode)		89		%
	$I_{LOAD} = 500\text{ mA}$ (PWM mode)		89		%
EN/MODE INPUT LOGIC					
High Threshold Voltage		1.2			V
Low Threshold Voltage				0.4	V
Leakage Current	$V_{EN} = V_{MODE} = 0.5\text{ V}$, 5.5 V		0.01	1	μA
SOFT START³					
	$C_{OUT} = 4.7\text{ }\mu\text{F}$, $V_{IN} = 3.6\text{ V}$ (time from $EN = 0$ to stable V_{OUT})				
Soft Start Period	$V_{OUT} = 1.82\text{ V}$		270	300	μs
	$V_{OUT} = 1.8\text{ V}$, 1.85 V , 1.875 V		80	100	μs
THERMAL SHUTDOWN					
Thermal Shutdown Threshold			150		$^\circ\text{C}$
Thermal Shutdown Hysteresis			30		$^\circ\text{C}$

¹ All limits are subject to change upon final temperature characterization and release.

² Transients not included in voltage accuracy specifications. For PFM mode, the V_{OUT} accuracy specification is for the lower point of the ripple.

³ Guaranteed by design.

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
VIN	−0.3 V to +6 V
V _{EN} /V _{MODE}	−0.3 V to +6 V
V _{FB} /V _{SW}	−0.3 V to VIN + 0.2 V
Operating Ambient Temperature	−40°C to +85°C
Operating Junction Temperature	−40°C to + 125°C @ 500 mA
Storage Temperature	−45°C to +150°C
Soldering (10 sec)	300°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C
ESD (electrostatic discharge)	
Machine Model	−100 V to +100 V
Human Body Model	−2000 V to +2000 V
Charged Device Model	−500 V to +500 V

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL RESISTANCE

The thermal resistance of the system, θ_{JA} , is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages. The junction-to-ambient thermal resistance is highly dependent on the application and board layout. In applications where high maximum power dissipation exists, attention to thermal board design is required. The value of θ_{JA} may vary, depending on PCB material, layout, and environmental conditions.

Table 4.

Package Type	θ_{JA}	Unit
6-Ball WLCSP		
2-Layer Board	105	°C/W
4-Layer Board	198	°C/W
Maximum Power Dissipation		
2-Layer Board	380	mW
4-Layer Board	202	mW

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

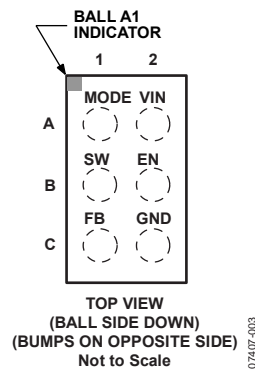


Figure 3. Pin Configuration

Table 5. Pin Function Descriptions

Pin No.	Mnemonic	Description
A1	MODE	Mode Select. This pin toggles between auto (PFM and PWM switching) and PWM modes. Set MODE low to allow the part to operate in auto mode. Pull MODE high to force the part to operate in PWM mode.
B1	SW	Switch Node.
C1	FB	Feedback Divider Input. Connect the output capacitor from FB to GND to set the output voltage ripple and to complete the control loop.
A2	VIN	Power Supply Input.
B2	EN	Enable. Pull this pin high to enable the part. Set this pin low to disable the part. Do not leave this pin floating.
C2	GND	Ground Pin.

TYPICAL PERFORMANCE CHARACTERISTICS

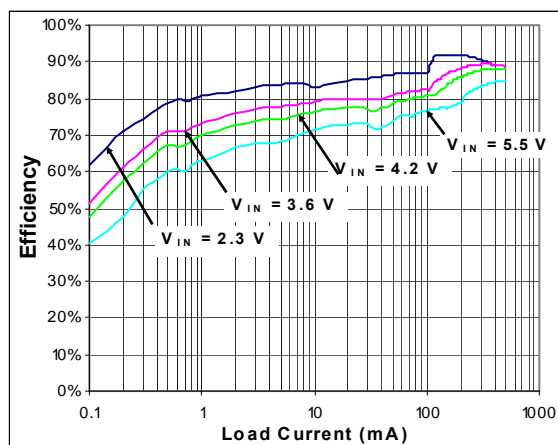
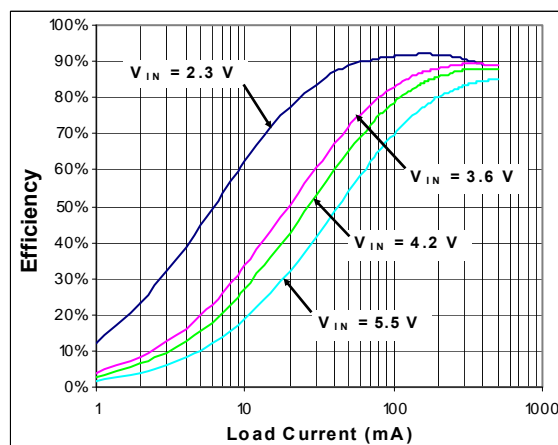
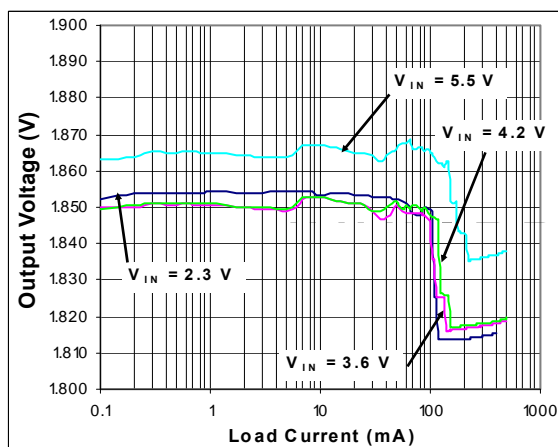
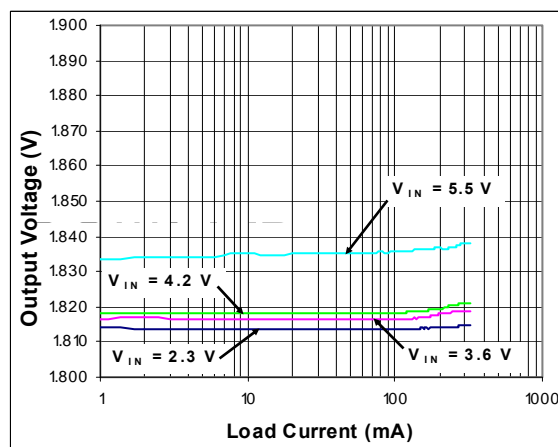
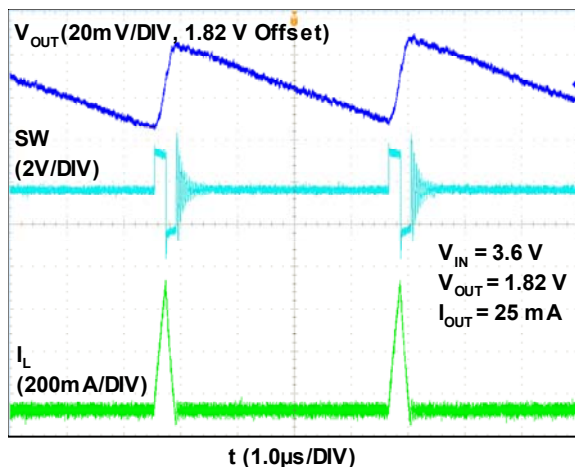
Figure 4. Efficiency vs. Load Current (Auto Mode, $V_{OUT} = 1.82\text{ V}$)Figure 7. Efficiency vs. Load Current (PWM Mode, $V_{OUT} = 1.82\text{ V}$)Figure 5. Output Voltage Accuracy (Auto Mode, $V_{OUT} = 1.82\text{ V}$)Figure 8. Output Voltage Accuracy (PWM Mode, $V_{OUT} = 1.82\text{ V}$)

Figure 6. PFM Mode Operation

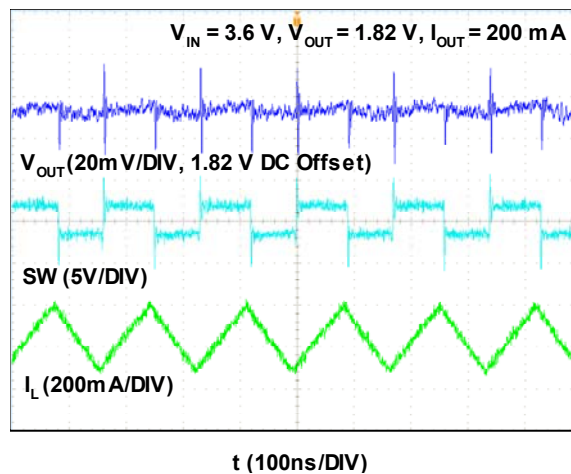


Figure 9. PWM Mode Operation

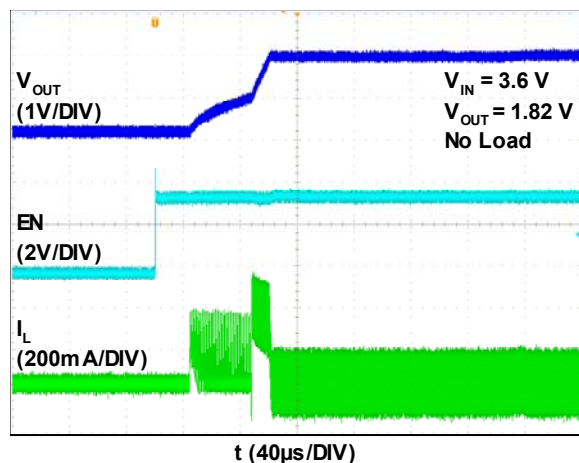


Figure 10. Start-Up Waveform (No Load, $V_{IN} = 3.6$ V, $V_{OUT} = 1.82$ V)

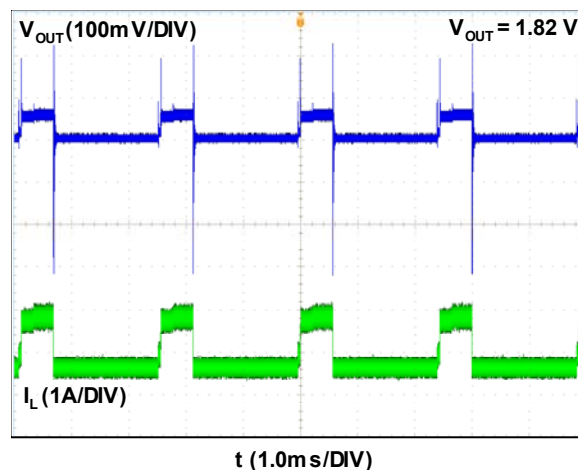


Figure 12. Output Short Circuit Response

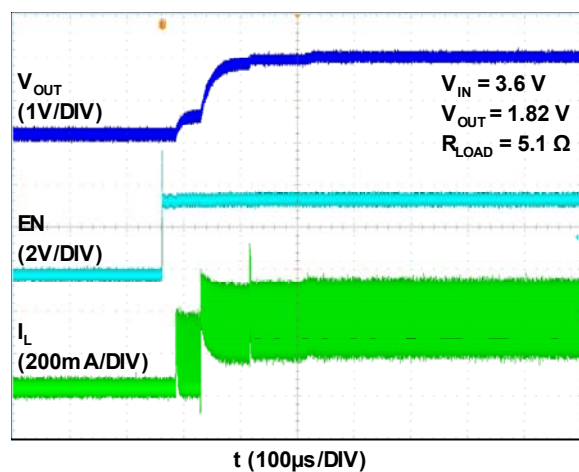


Figure 11. Start-Up Waveform ($R_{LOAD} = 5.1 \Omega$, $V_{IN} = 3.6$ V, $V_{OUT} = 1.82$ V)

THEORY OF OPERATION

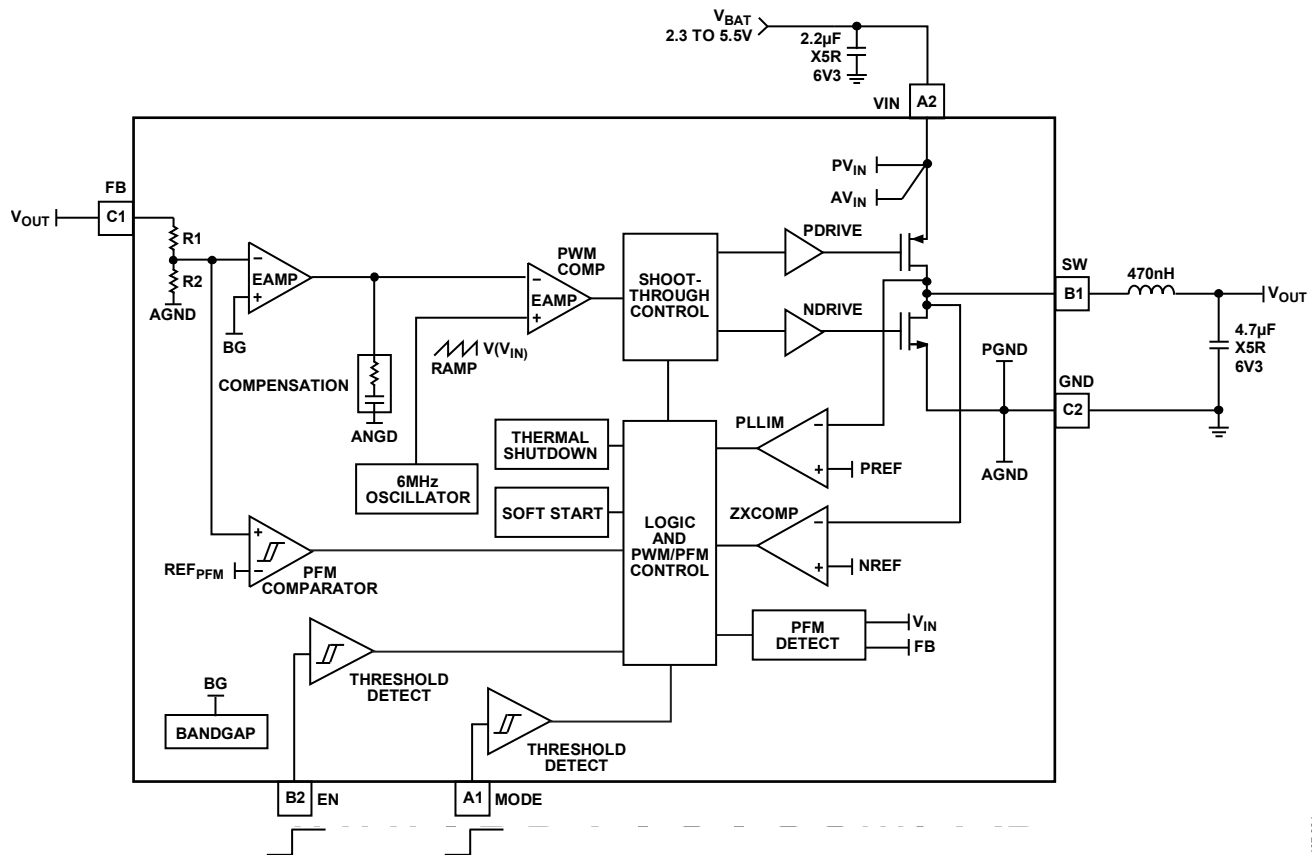


Figure 13. Internal Block Diagram

OVERVIEW

The ADP2121 is a high efficiency, synchronous, step-down, dc-to-dc converter that operates from a 2.3 V to 5.5 V input voltage. It provides up to 500 mA of continuous output current at a fixed 1.80 V, 1.82 V, 1.85 V, or 1.875 V (typical) output voltage. The 6 MHz operating frequency enables the use of tiny external components. The internal control schemes of the ADP2121 give excellent stability and transient response. External control for mode selection and part enabling provides power-saving options that are aided by internal features such as synchronous rectification and compensation. Other internal features such as current limit, soft start, undervoltage lockout, output-to-ground short circuit protection, and thermal shutdown provide protection for internal and external circuit components.

MODE SELECTION

The ADP2121 has two modes of operation, determined by the state of the MODE pin: auto and PWM.

Pull the MODE pin high to force the converter to operate in PWM mode, regardless of the output current. Otherwise, set MODE low to allow the converter to automatically enter the power saving PFM mode at light load currents. Do not leave this pin floating.

Pulse-Width Modulation (PWM) Mode

The PWM mode forces the part to maintain a fixed frequency of 6 MHz (typical) over all load conditions. The converter controls the amount of power delivered to the load by varying the duty cycle of the internal oscillator. This control provides excellent stability, transient response, and output regulation, but results in lower efficiencies at light load currents.

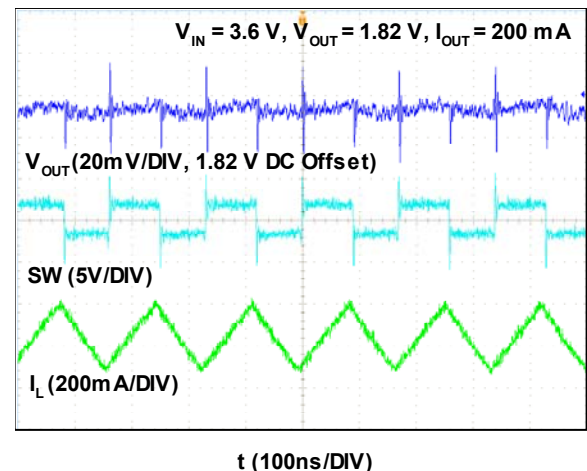
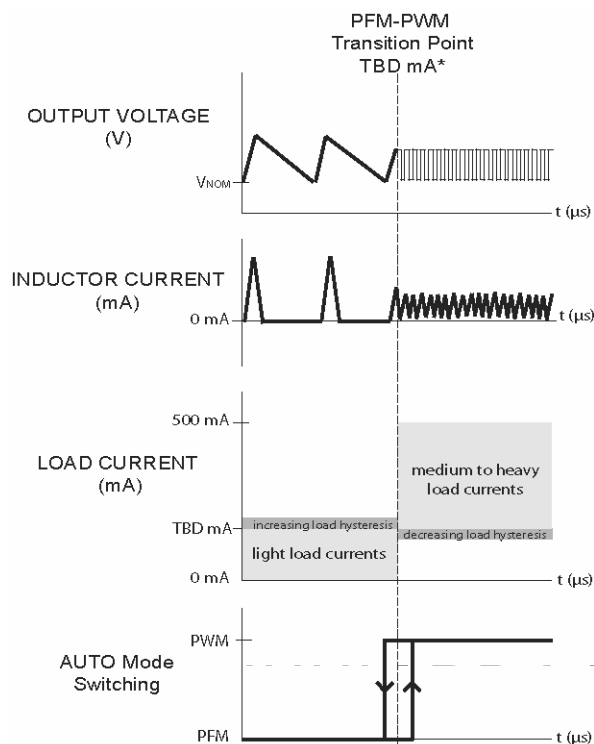


Figure 14. Typical PWM Operation ($V_{IN} = 3.6\text{ V}$, $V_{OUT} = 1.82\text{ V}$, $I_{LOAD} = 150\text{ mA}$)

Auto Mode (PFM-PWM Switching)

Auto mode is a power saving feature that enables the converter to switch between PWM and PFM in response to the output load. The ADP2121 operates in PFM mode for light load currents and switches to PWM mode for medium and heavy load currents (Figure 15).



* PFM-PWM transition point varies with input voltage. Hysteresis also exists in the direction of the load change.

Figure 15. PFM-to-PWM Transition Point

Pulse-Frequency Modulation

When the converter is operating under light load conditions, the effective switching frequency and supply current are decreased and varied using PFM to regulate the output voltage. This results in improved efficiencies and lower quiescent currents. In PFM mode, as shown in Figure 16, the converter only switches when necessary to keep the output voltage within the PFM limits set by an internal comparator. Switching stops when the upper limit is reached and resumes when the lower limit is reached.

Once the upper level is reached, the output stage and oscillator turn off to reduce the quiescent current. During this stage, the output capacitor supplies the current to the load. As the output capacitor discharges and the output voltage reaches the lower PFM comparator threshold, switching resumes and the process repeats. The output voltage, switching node voltage, and inductor current during this process are shown in Figure 16.

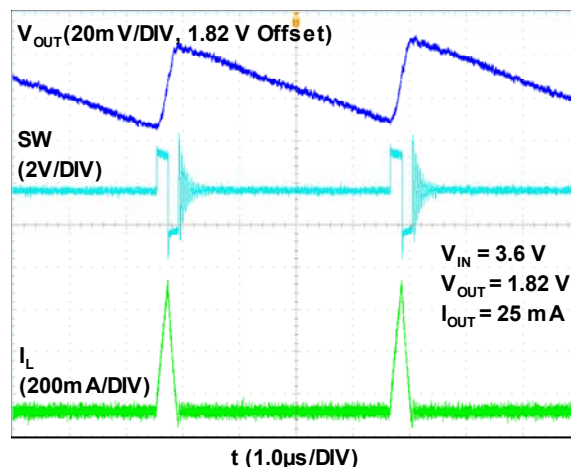


Figure 16. Typical PFM Operation ($V_{IN} = 3.6\text{ V}$, $V_{OUT} = 1.82\text{ V}$, $I_{LOAD} = 25\text{ mA}$)

Mode Transition

The converter switches between PFM and PWM automatically to maintain optimal transient response and efficiency. The mode transition point depends on input voltage. Hysteresis exists in the transition point to prevent instability and decreased efficiencies that could result if the converter were able to oscillate between PFM and PWM for a fixed input voltage and load current.

A switch from PFM to PWM occurs when the output voltage dips below the lower PFM comparator threshold. Switching to PWM allows the converter to maintain efficiency and supply a heavier current to the load.

A switch from PWM to PFM occurs when the converter outputs a decreased peak current for multiple consecutive switching cycles. Switching to PFM allows the converter to save power and supply a lighter load current with fewer switching cycles.

Figure 16 shows the threshold voltage in PFM mode is slightly higher to ensure that the converter is able to supply enough current when transitioning into PWM mode.

ENABLE/SHUTDOWN

The EN input turns the ADP2121 on or off. Connect EN to PGND or logic low to shut down the part and reduce the current consumption to $0.1\text{ }\mu\text{A}$ (typical). Connect EN to VIN or logic high to enable the part. Do not leave this pin floating.

INTERNAL CONTROL FEATURES

Overcurrent Protection

To ensure that excessively high currents do not damage the inductor, the ADP2121 incorporates cycle-by-cycle overcurrent protection. This function is accomplished by monitoring the instantaneous peak current on the power PMOS switch. If this current exceeds the maximum level (1 A typical), then the PMOS is immediately turned off. This minimizes the potential

for damage to power components during certain faults and transient events.

Soft Start

To prevent excessive input inrush current at startup, the ADP2121 operates with an internal soft start. When EN goes high, or when the part recovers from a fault (UVLO, TSD, or short-circuit protection), a soft start timer begins. The soft start timer corresponds to the maximum soft start period for the given fixed output voltage. During this time, the peak current limit is gradually increased to its maximum. As seen in the start-up waveforms in the Typical Performance Characteristics, the output voltage passes through several stages to ensure that each stages of the converter is able to startup effectively and in proper sequence. After the soft start period has expired, the peak current limit remains at 1 A (typical) and the part enters the operating mode determined by the MODE pin.

Synchronous Rectification

In addition to the P-channel MOSFET switch, the ADP2121 includes an N-channel MOSFET synchronous rectifier. The synchronous rectifier improves efficiency, especially for small load currents, and reduces cost and board space by eliminating the need for an external rectifier.

Compensation

The control loop is internally compensated to deliver maximum performance with no additional external components. The error amplifier compares the regulated output voltage on the feedback pin (FB) to an internal reference voltage. The ADP2121 has been designed to work with 0.47 μ H chip inductors and 4.7 μ F capacitors (see Table 6 and Table 7.) Other values may reduce performance and/or stability.

Undervoltage Lockout (UVLO)

If the input voltage is below the UVLO threshold, the ADP2121 automatically turns off the power switches and places the part into a low power consumption mode. This prevents potentially

erratic operation at low input voltages. The UVLO levels have approximately 100 mV of hysteresis to ensure glitch-free startup.

Output Short Circuit Protection

If the output voltage is inadvertently shorted to GND, a standard dc-to-dc controller would deliver maximum power into that short. This could result in a potentially catastrophic failure. To prevent this, the ADP2121 senses when the output voltage is below the SCP threshold (typically 1.2 V). At this point, the controller turns off for approximately 1.8 ms and then automatically initiates a soft start sequence. This cycle repeats until the short is removed or the part is disabled. This dramatically reduces the power delivered into the short circuit, yet still allows the converter to recover if the fault is removed.

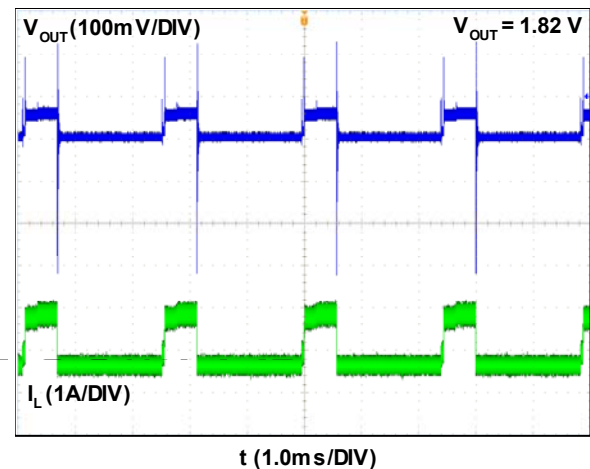


Figure 17. Output Short Circuit Protection

Thermal Shutdown (TSD) Protection

The ADP2121 also includes TSD protection. If the die temperature exceeds 150°C (typical), the TSD protection activates and turn off the power devices. They remain off until the die temperature falls below 120°C (typical), at which point

APPLICATIONS INFORMATION

The external component selection for the ADP2121 applications circuit is driven by the load requirement and begins with the selection of Inductor L (see). Once the inductor is chosen, C_{IN} and C_{OUT} can be selected.

INDUCTOR SELECTION

The high switching frequency of the ADP2121 allows for minimal output voltage ripple, even with small inductors. Inductor sizing is a trade-off between efficiency and transient response. A small inductor leads to a larger inductor current ripple that provides excellent transient response, but degrades efficiency. Due to the high switching frequency of the ADP2121, multilayer ceramic inductors can be used for an overall smaller solution size. Shielded ferrite core inductors are recommended for their low core losses and low electromagnetic interference (EMI).

As a guideline, the inductor peak-to-peak current ripple is typically set to

$$\Delta I_L = 0.45 \times I_{LOAD} \quad (1)$$

where I_{LOAD} is the maximum output current. The largest ripple current, ΔI_L , occurs at the maximum input voltage.

$$L_{IDEAL} = \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN(MAX)} \times f_{SW} \times 0.45 \times I_{LOAD(MAX)}} \quad (2)$$

where f_{SW} is the switching frequency.

It is important that the inductor be capable of handling the maximum peak inductor current, I_{PK} , determined by the following equation:

$$I_{PK} = I_{LOAD(MAX)} + \Delta I_L / 2 \quad (3)$$

The dc current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Table 6 shows some typical surface mount inductors that work well in ADP2121 applications.

INPUT CAPACITOR SELECTION

The input capacitor must be able to support the maximum input operating voltage and the maximum rms input current. The maximum rms input current flowing through the input capacitor is at maximum $I_{OUT}/2$. Select an input capacitor capable of withstanding the rms input current for the maximum load current in the application using the following equation:

$$I_{rms} = I_{OUTMAX} \times \frac{\sqrt{V_{OUT} \times (V_{IN} - V_{OUT})}}{V_{IN}} \quad (4)$$

The input capacitor reduces the input voltage ripple caused by the switch currents on the VIN pin. Place the input capacitor as close as possible to the VIN pin.

In principle, different types of capacitors can be considered, but for battery-powered applications, the best choice is the multilayer ceramic capacitor, due to its small size and equivalent series resistance (ESR). Table 7 offers input capacitor suggestions.

It is recommended that the VIN pin be bypassed with a 2.2 μF or larger ceramic input capacitor if the supply line has a distributed capacitance of at least 10 μF . If not, at least a 10 μF capacitor is recommended on the input supply pin. The input capacitor can be increased without any limit for better input voltage filtering. X5R or X7R dielectrics are recommended, with a voltage rating of 6.3 V or 10 V. Y5U and Z5U dielectrics are not recommended, due to their poor temperature and dc bias characteristics.

OUTPUT CAPACITOR SELECTION

The output capacitor selection affects both the output voltage ripple and the loop dynamics of the converter. For a given loop crossover frequency (the frequency at which the loop gain drops to 0 dB), the maximum voltage transient excursion (overshoot) is inversely proportional to the value of the output capacitor. The ADP2121 has been designed to operate with small ceramic capacitors in the 4.7 μF to 10 μF range that have low ESR and equivalent series inductance (ESL) and are able, therefore, to meet tight output voltage ripple specifications. X5R or X7R dielectrics are recommended with a voltage rating of 6.3 V. Table 7 shows a list of input and output MLCC capacitors recommended for ADP2121 applications.

When choosing output capacitors, it is also important to account for the loss of capacitance due to output voltage dc bias. This may result in using a capacitor with a higher rated voltage to achieve the desired capacitance value. Additionally, if ceramic output capacitors are used, the capacitor rms ripple current rating should always meet the application requirements. The rms ripple current is calculated as:

$$I_{rms(COUT)} = \frac{1}{2\sqrt{3}} \times \frac{V_{OUT} \times (V_{IN(MAX)} - V_{OUT})}{L \times f_{SW} \times V_{IN(MAX)}} \quad (5)$$

At nominal load currents, the converter operates in forced frequency (PWM) mode, and the overall output voltage ripple is the sum of the voltage spike caused by the output capacitor ESR plus the voltage ripple caused by charging and discharging the output capacitor.

$$\Delta V_{OUT} = \Delta I_L \times (ESR + 1/(8 \times C_{OUT} \times f_{SW})) \quad (6)$$

The largest voltage ripple occurs at the highest input voltage, V_{IN} . At light load currents, if MODE is set low, then the converter operates in power save (PFM) mode and the output voltage ripple increases.

Table 6. Recommended Inductor Selection

Manufacturer	Series	Inductance (μH)	DCR (Ω)	Current Rating (mA)	Size (L \times W \times H) (mm)	Package
Murata	LQM2HP_G0	$0.47 \pm 20\%$	$0.040 \pm 25\%$	1800	$2.5 \times 2.0 \times 0.90$	1008
	LQM21PNR47MC0D	$0.47 \pm 20\%$	$0.120 \pm 25\%$	1100	$2.0 \times 1.25 \times 0.50$	0805
Taiyo Yuden	BRC1608TR45M	$0.45 \pm 20\%$	$0.117 \pm 30\%$	800	$1.6 \times 0.8 \times 0.8$	0603

Table 7. Recommended Input and Output Capacitor Selection

Manufacturer	Capacitance (μF)	Voltage Rating (V)	Temperature Coefficient	Part Number	Size (L \times W \times H) (mm)	Package
Input						
Murata	2.2	6.3	X5R	GRM155R60J225M	$1.0 \times 0.5 \times 0.5$	0402
Taiyo Yuden	2.2	6.3	X5R	JMK105BJ225MV-F	$1.0 \times 0.5 \times 0.5$	0402
Panasonic	2.2	6.3	X5R	ECJ-0EB0J225M	$1.0 \times 0.5 \times 0.5$	0402
Output						
Murata	4.7	6.3	X5R	GRM188R60J475K	$1.6 \times 0.8 \times 0.8$	0603
Taiyo Yuden	4.7	4	X5R	AMK105BJ475MV-F	$1.0 \times 0.5 \times 0.5$	0402
Panasonic	4.7	6.3	5R	ECJ-0EB0J475M	$1.0 \times 0.5 \times 0.5$	0402

PCB LAYOUT GUIDE

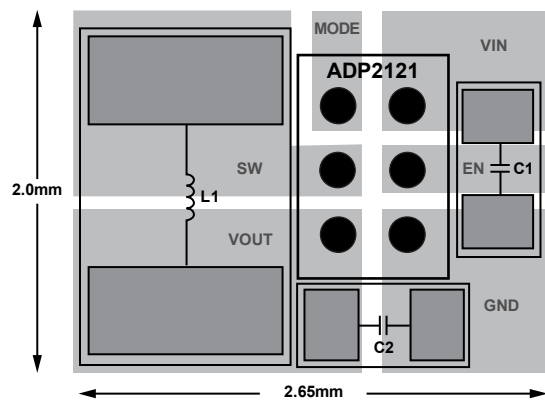


Figure 18. Example Layout for an ADP2121 Application

For high efficiency, good regulation, and stability with the ADP2121, a well-designed printed circuit board layout is required.

Use the following guidelines when designing printed circuit boards:

- Keep the low ESR input capacitor, C_{IN} , close to V_{IN} and GND.
- Keep high current traces as short and as wide as possible.
- Avoid routing high impedance traces near any node connected to SW or near the inductor to prevent radiated noise injection.

OUTLINE DIMENSIONS

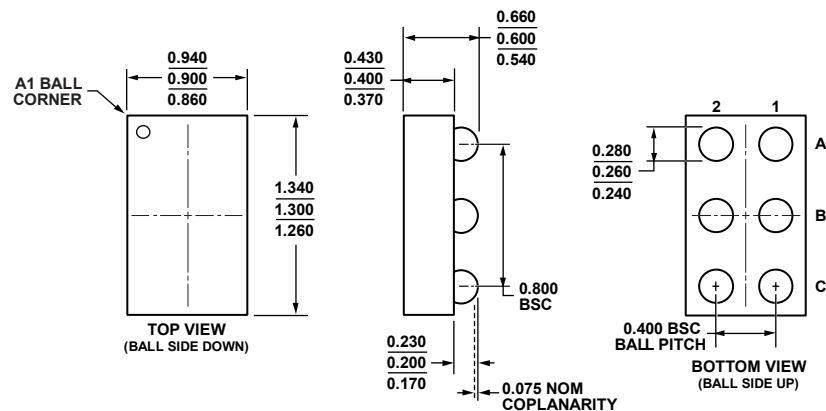


Figure 19. 6-Ball Wafer Level Chip Scale Package (WLCSP)
(CB-6-4)
Dimensions shown in millimeters

ORDERING GUIDE

Model	Temperature Range	Output Voltage	Startup Time	Package Description	Package Option	Branding
ADP2121YCBZ-1.80R7 ¹	−40 °C to +85 °C	1.800 V	80 μs	6-Ball Wafer Level Chip Scale Package [WLCSP]	CB-6-4	L92
ADP2121YCBZ-1.82R7 ²	−40 °C to +85 °C	1.820 V	270 μs	6-Ball Wafer Level Chip Scale Package [WLCSP]	CB-6-4	L93
ADP2121YCBZ-1.85R7 ³	−40 °C to +85 °C	1.850 V	80 μs	6-Ball Wafer Level Chip Scale Package [WLCSP]	CB-6-4	L94
ADP2121YCBZ-1.875R7 ⁴	−40 °C to +85 °C	1.875 V	80 μs	6-Ball Wafer Level Chip Scale Package [WLCSP]	CB-6-4	L95

¹ Z = RoHS Compliant Part.
² Z = RoHS Compliant Part.
³ Z = RoHS Compliant Part.
⁴ Z = RoHS Compliant Part.